

GA150KS61U

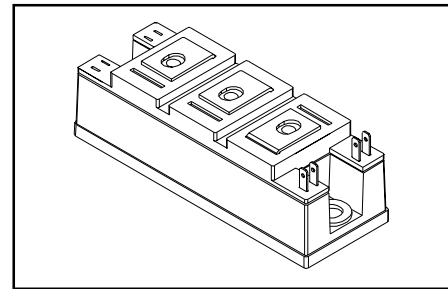
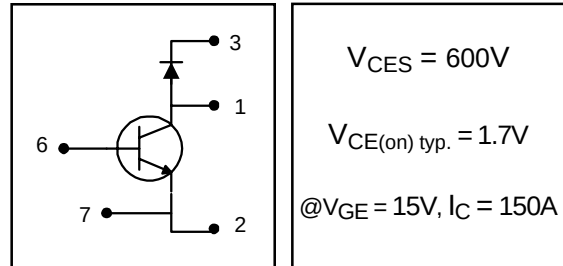
Low Side Switch Chopper Module
Ultra-Fast™ Speed IGBT

Features

- Generation 4 IGBT technology
- UltraFast: Optimized for high operating frequencies 8-40 kHz in hard switching, >200 kHz in resonant mode
- Very low conduction and switching losses
- HEXFRED™ antiparallel diodes with ultra- soft recovery
- Industry standard package
- UL approved

Benefits

- Increased operating efficiency
- Direct mounting to heatsink
- Performance optimized for power conversion: UPS, SMPS, Welding
- Lower EMI, requires less snubbing



Absolute Maximum Ratings

	Parameter	Max.	Units
V_{CES}	Collector-to-Emitter Voltage	600	V
$I_C @ T_C = 25^\circ C$	Continuous Collector Current	150	A
I_{CM}	Pulsed Collector Current①	300	
I_{LM}	Peak Switching Current②	300	
I_{FM}	Peak Diode Forward Current	300	
V_{GE}	Gate-to-Emitter Voltage	± 20	V
V_{ISOL}	RMS Isolation Voltage, Any Terminal To Case, $t = 1 \text{ min}$	2500	W
$P_D @ T_C = 25^\circ C$	Maximum Power Dissipation	440	
$P_D @ T_C = 85^\circ C$	Maximum Power Dissipation	230	$^\circ C$
T_J	Operating Junction Temperature Range	-40 to +150	
T_{STG}	Storage Temperature Range	-40 to +125	

Thermal / Mechanical Characteristics

	Parameter	Typ.	Max.	Units
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case - IGBT	—	0.28	$^\circ C/W$
$R_{\theta JC}$	Thermal Resistance, Junction-to-Case - Diode	—	0.35	
$R_{\theta CS}$	Thermal Resistance, Case-to-Sink - Module	0.1	—	N·m
	Mounting Torque, Case-to-Heatsink	—	4.0	
	Mounting Torque, Case-to-Terminal 1, 2 & 3③	—	3.0	g
	Weight of Module	200	—	

Electrical Characteristics @ $T_J = 25^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
$V_{(BR)CES}$	Collector-to-Emitter Breakdown Voltage	600	—	—	V	$V_{GE} = 0V, I_C = 1mA$
$V_{CE(on)}$	Collector-to-Emitter Voltage	—	1.7	2.3		$V_{GE} = 15V, I_C = 150A$
		—	1.7	—		$V_{GE} = 15V, I_C = 150A, T_J = 125^\circ\text{C}$
$V_{GE(th)}$	Gate Threshold Voltage	3.0	—	6.0		$I_C = 750\mu A$
$\Delta V_{GE(th)}/\Delta T_J$	Temperature Coeff. of Threshold Voltage	—	-11	—	mV/ $^\circ\text{C}$	$V_{CE} = V_{GE}, I_C = 750\mu A$
g_{fe}	Forward Transconductance ④	—	152	—	S	$V_{CE} = 25V, I_C = 150A$
I_{CES}	Collector-to-Emitter Leaking Current	—	—	1.0	mA	$V_{GE} = 0V, V_{CE} = 600V$
		—	—	10		$V_{GE} = 0V, V_{CE} = 600V, T_J = 125^\circ\text{C}$
V_{FM}	Diode Forward Voltage - Maximum	—	1.4	2.0	V	$I_F = 150A, V_{GE} = 0V$
		—	1.4	—		$I_F = 150A, V_{GE} = 0V, T_J = 125^\circ\text{C}$
I_{GES}	Gate-to-Emitter Leakage Current	—	—	250	nA	$V_{GE} = \pm 20V$

Dynamic Characteristics - $T_J = 125^\circ\text{C}$ (unless otherwise specified)

	Parameter	Min.	Typ.	Max.	Units	Conditions
Q_g	Total Gate Charge (turn-on)	—	624	937	nC	$V_{CC} = 400V$
Q_{ge}	Gate - Emitter Charge (turn-on)	—	121	182		$I_C = 94A$
Q_{gc}	Gate - Collector Charge (turn-on)	—	212	317		$T_J = 25^\circ\text{C}$
$t_{d(on)}$	Turn-On Delay Time	—	241	—	ns	$R_{G1} = 27\Omega, R_{G2} = 0\Omega,$
t_r	Rise Time	—	145	—		$I_C = 150A$
$t_{d(off)}$	Turn-Off Delay Time	—	336	—		$V_{CC} = 360V$
t_f	Fall Time	—	227	—		$V_{GE} = \pm 15V$
E_{on}	Turn-On Switching Energy	—	6.0	—	mJ	
$E_{off(1)}$	Turn-Off Switching Energy	—	12	—		
$E_{ts(1)}$	Total Switching Energy	—	19	33		
C_{ies}	Input Capacitance	—	13878	—	pF	$V_{GE} = 0V$
C_{oes}	Output Capacitance	—	867	—		$V_{CC} = 30V$
C_{res}	Reverse Transfer Capacitance	—	181	—		$f = 1\text{ MHz}$
t_{rr}	Diode Reverse Recovery Time	—	139	—	ns	$I_C = 150A$
I_{rr}	Diode Peak Reverse Current	—	100	—	A	$R_{G1} = 27\Omega$
Q_{rr}	Diode Recovery Charge	—	6938	—	nC	$R_{G2} = 0\Omega$
$di_{(rec)M}/dt$	Diode Peak Rate of Fall of Recovery During t_b	—	4682	—	A/ μs	$V_{CC} = 360V$ $di/dt = 1400A/\mu s$

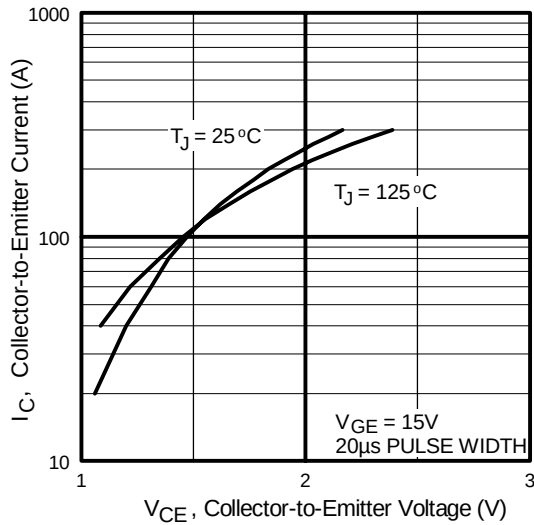


Fig. 1 - Typical Output Characteristics

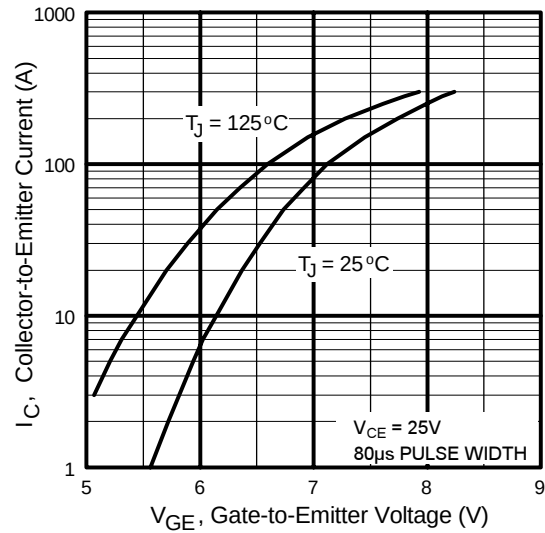


Fig. 2 - Typical Transfer Characteristics

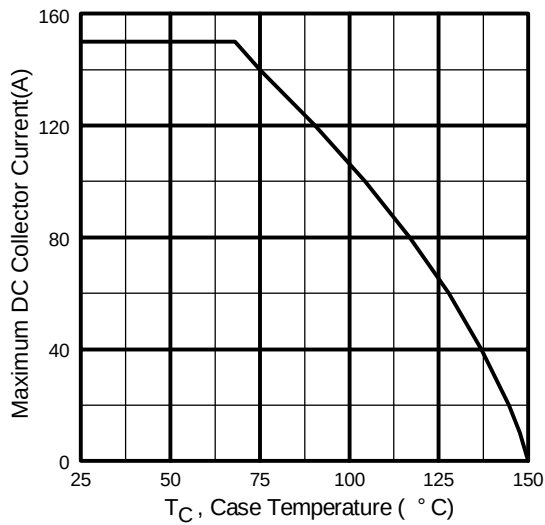


Fig. 3 - Maximum Collector Current vs. Case Temperature

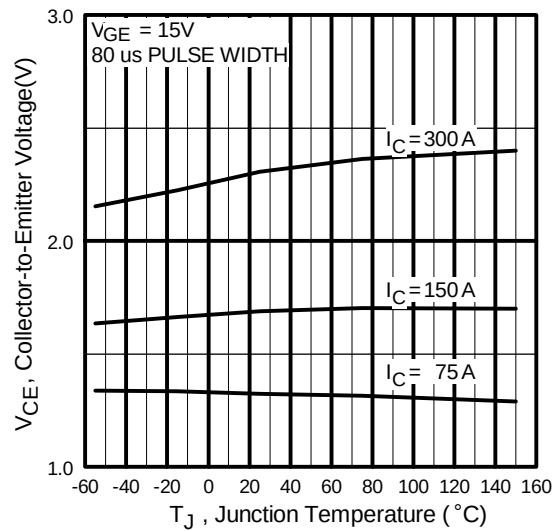


Fig. 4 - Typical Collector-to-Emitter Voltage vs. Junction Temperature

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IR Rectifier

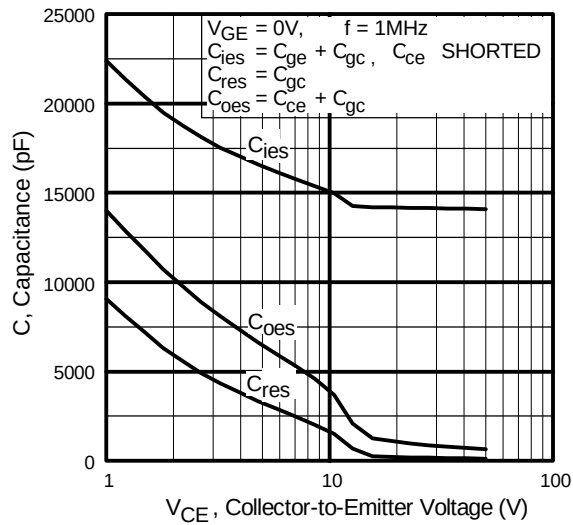


Fig. 5 - Typical Capacitance vs. Collector-to-Emitter Voltage

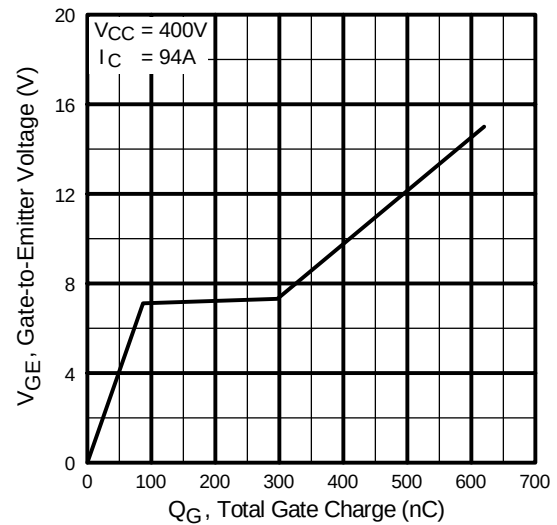


Fig. 6 - Typical Gate Charge vs. Gate-to-Emitter Voltage

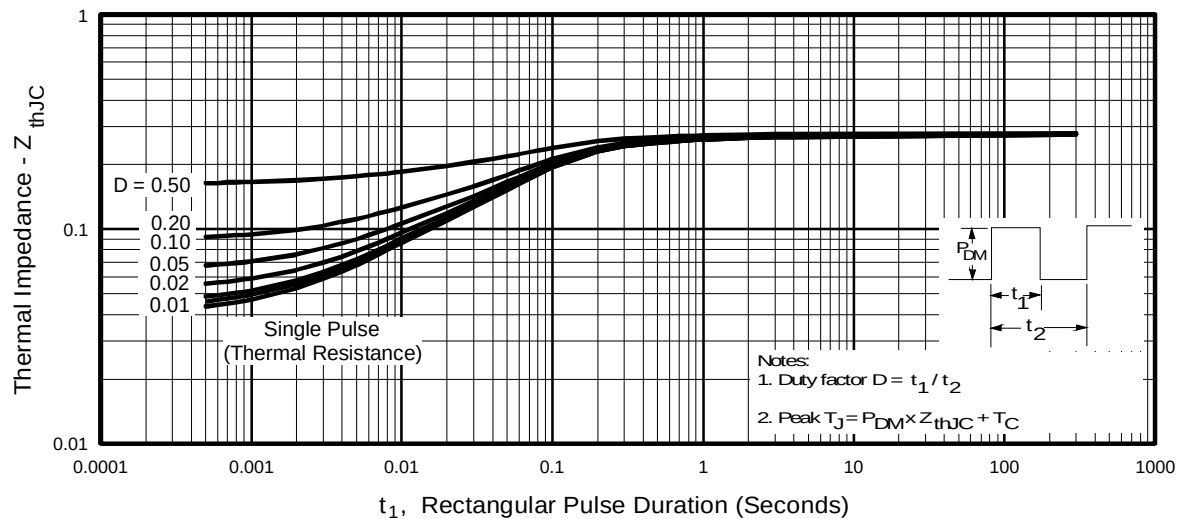


Fig. 7 - Maximum Effective Transient Thermal Impedance, Junction-to-Case

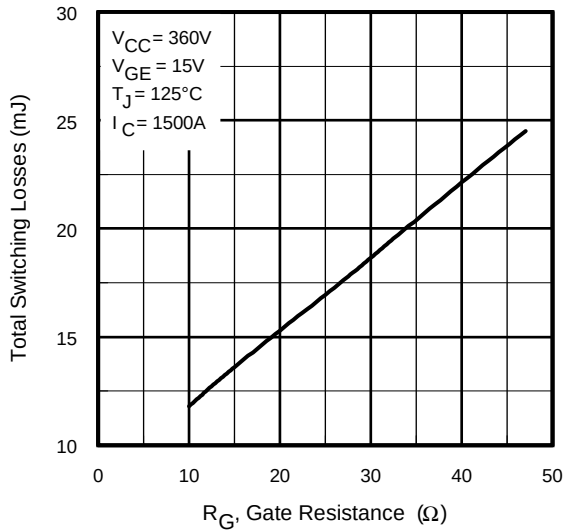


Fig. 8 - Typical Switching Losses vs. Gate Resistance

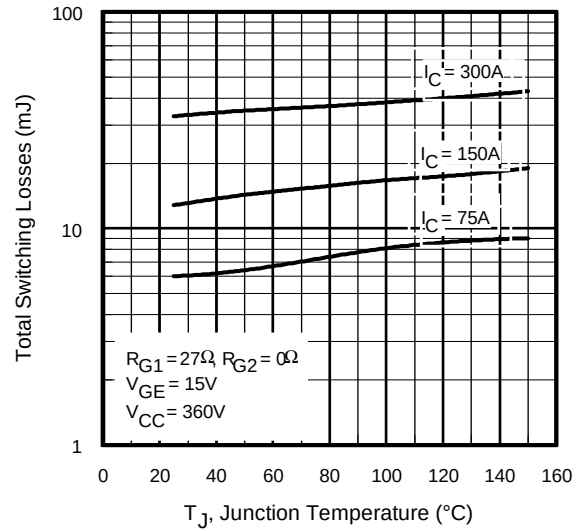


Fig. 9 - Typical Switching Losses vs. Junction Temperature

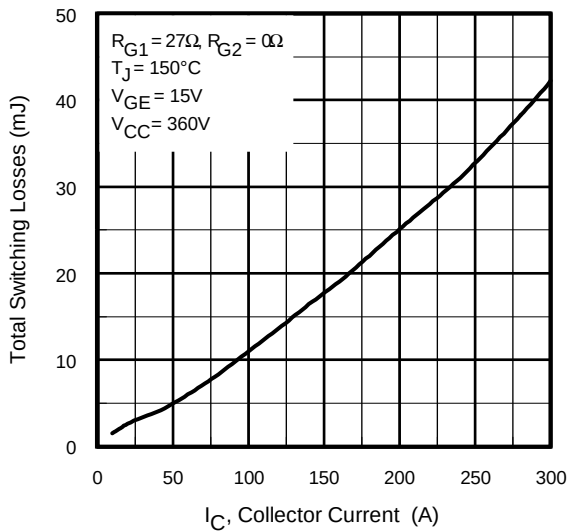


Fig. 10 - Typical Switching Losses vs. Collector-to-Emitter Current

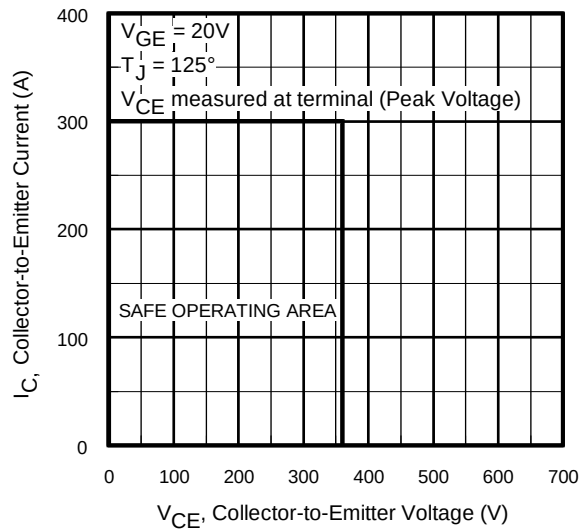


Fig. 11 - Reverse Bias SOA

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IR Rectifier

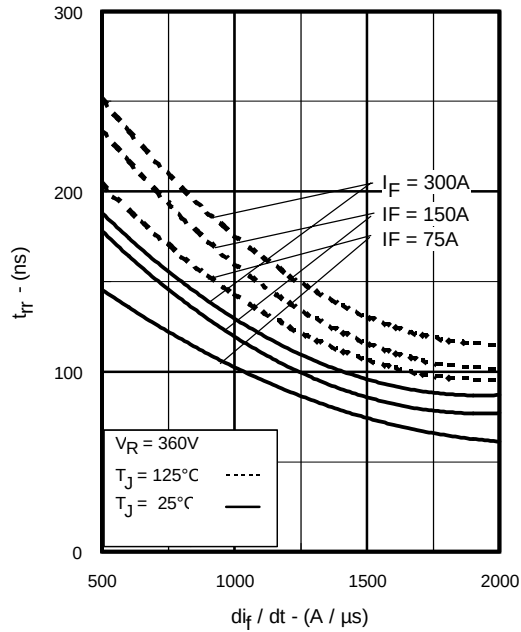


Fig. 12 - Typical Reverse Recovery vs. di_f/dt

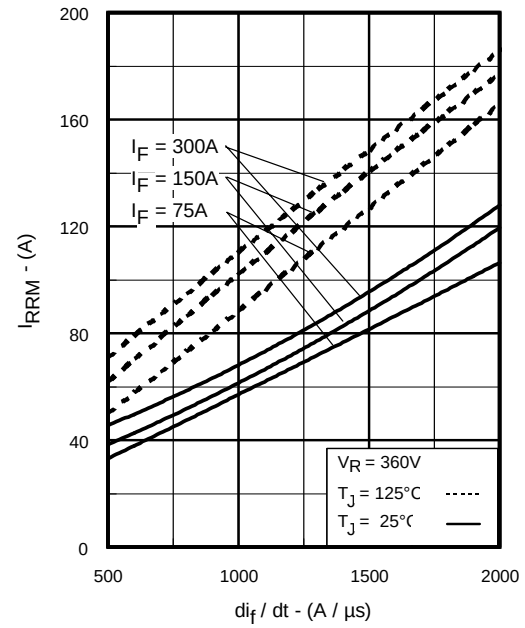


Fig. 13 - Typical Recovery Current vs. di_f/dt

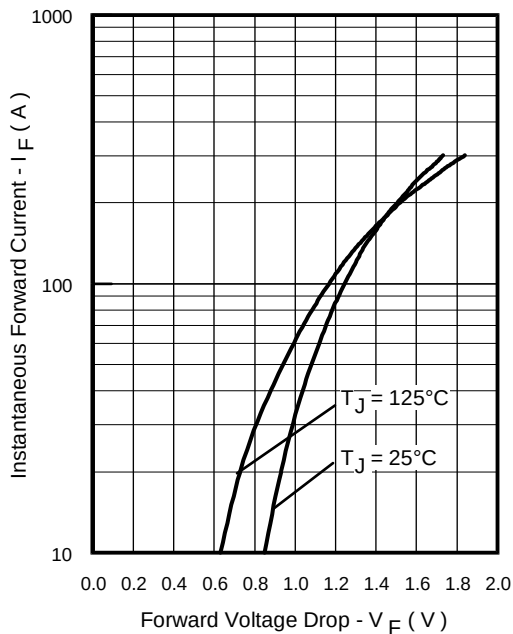


Fig. 14 - Typical Forward Voltage Drop vs. Instantaneous Forward Current

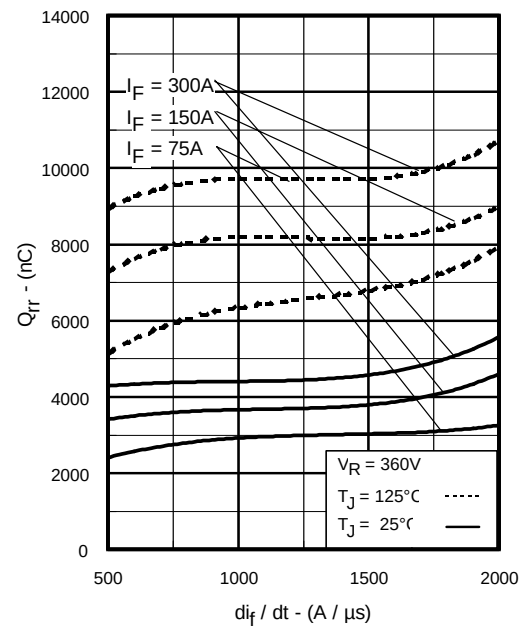


Fig. 15 - Typical Stored Charge vs. di_f/dt

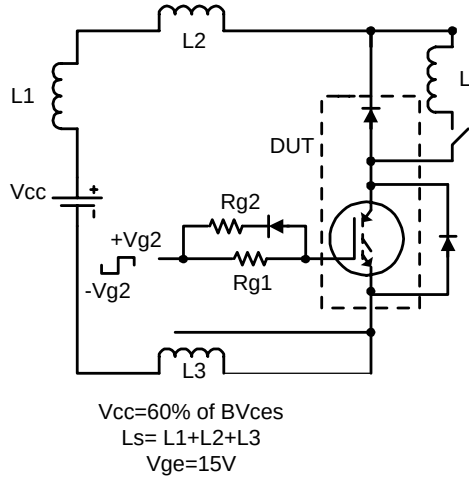


Fig. 16a - Test Circuit for Measurement of I_{LM} , E_{on} , $E_{off}(\text{diode})$, t_{rr} , Q_{rr} , I_{rr} , $t_{d(on)}$, t_r , $t_{d(off)}$, t_f

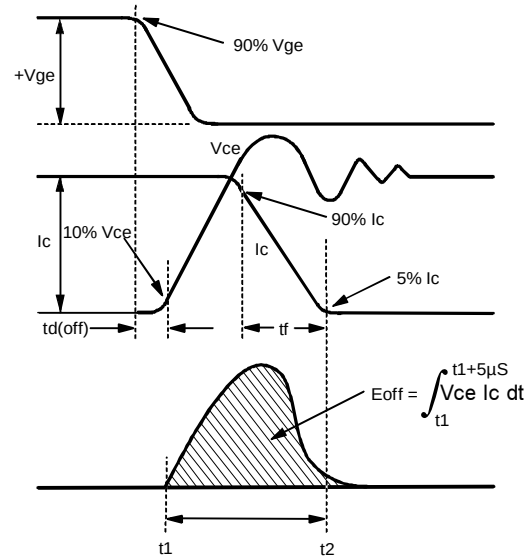


Fig. 16b - Test Waveforms for Circuit of Fig. 16a, Defining E_{off} , $t_{d(off)}$, t_f

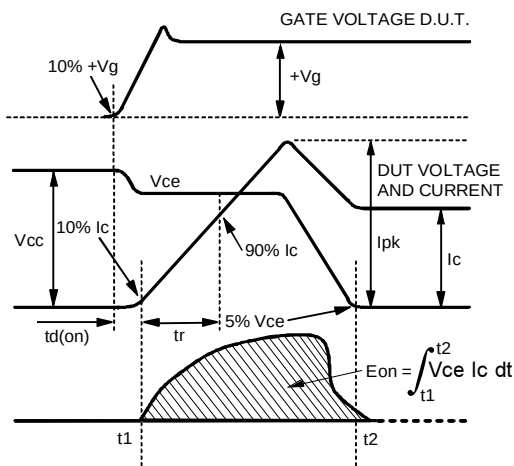


Fig. 16c - Test Waveforms for Circuit of Fig. 16a, Defining E_{on} , $t_{d(on)}$, t_r

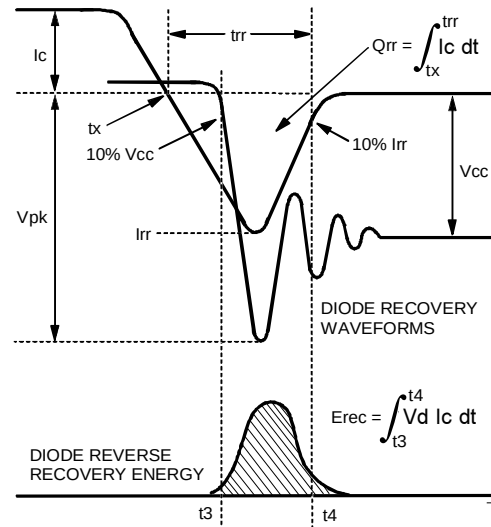


Fig. 16d - Test Waveforms for Circuit of Fig. 16a, Defining E_{rec} , t_{rr} , Q_{rr} , I_{rr}

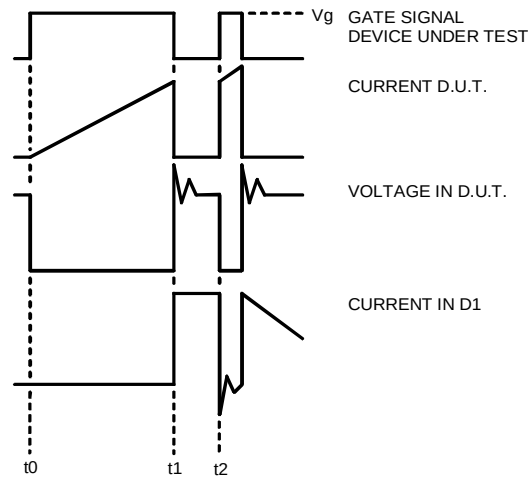


Figure 16e. Macro Waveforms for Figure 17's Test Circuit

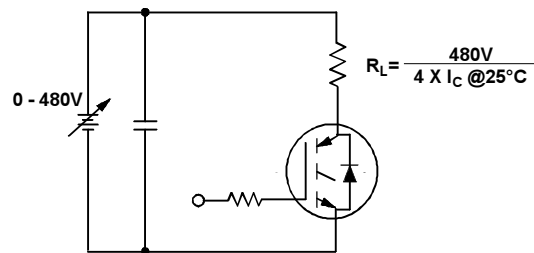
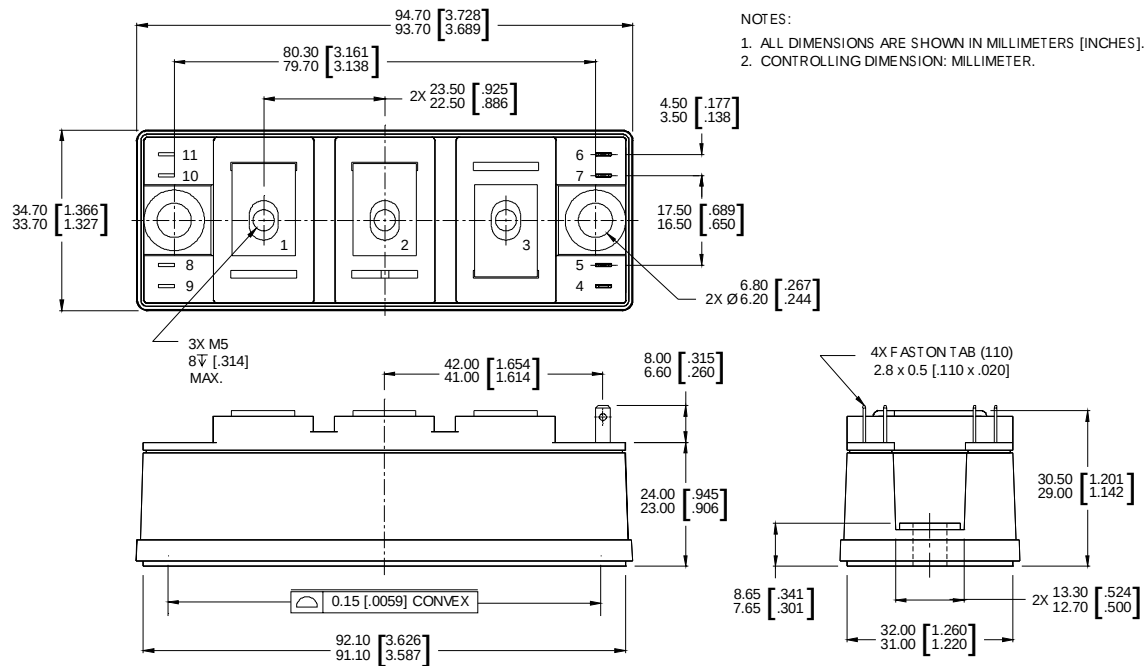


Figure 17. Pulsed Collector Current
Test Circuit

Notes:

- ① Repetitive rating; $V_{GE} = 20V$, pulse width limited by max. junction temperature.
- ② See fig. 16
- ③ For screws M5x0.8
- ④ Pulse width 80 μ s; single shot.

Case Outline — INT-A-PAK



Data and specifications subject to change without notice.
This product has been designed and qualified for the Industrial market.
Qualification Standards can be found on IR's Web site.

International
IR Rectifier

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